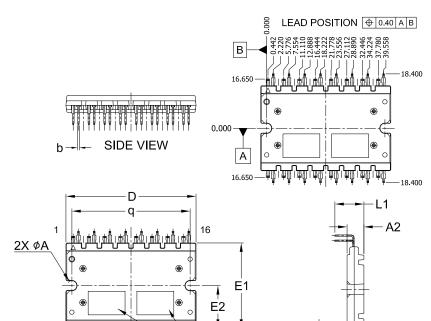




APM32 44.00x28.80x5.70CASE MODHM ISSUE A

DATE 01 AUG 2023

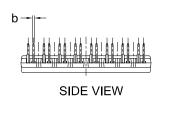


MARK AREA

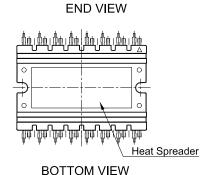
NOTES:

- 1. DIMENSIONING AND TOLERANCING PER. ASME Y14.5M, 2009.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR EXTRUSIONS.

	MILLIMETERS			
DIM	MIN.	NOM.	MAX.	
A2	5.60	5.70	5.80	
b	0.50	0.60	0.70	
С	0.45	0.50	0.60	
D	43.80	44.00	44.20	
E1	28.60	28.80	29.00	
E2	14.25	14.40	14.55	
L1	9.50	9.80	10.10	
q	39.85	40.00	40.15	
ΦA	3.20	3.30	3.40	



TOP VIEW



GENERIC MARKING DIAGRAM*

XXXXXXXXXXXXXXX ZZZ ATYWW NNNNNNN XXXX = Specific Device Code

ZZZ = Lot ID

AT = Assembly & Test Location

Y = Year W = Work Week

NNN = Serial Number

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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DESCRIPTION:	APM32 44.00x28.80x5.70		PAGE 1 OF 1

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